

Anti-Surge, High Power Thick Film Chip Resistors



LINKS TO ADDITIONAL RESOURCES



The anti-surge thick film chip resistor series combines a significantly higher power rating and pulse load performance as compared to standard chip resistors.

FEATURES

- · Excellent surge pulse capability
- Superior ESD surge characteristics
- · High power rating
- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Automotive
- Industrial
- Telecommunications
- Medical

DESCRIPTION	RCS0402 e3	RCS0603 e3	RCS0805 e3	RCS1206 e3		
Imperial size	0402	0603	0805	1206		
Metric size code	RR1005M	RR1608M	RR2012M	RR3126M		
Resistance range		1 Ω to 10 M Ω	; jumper (0 Ω)			
Resistance tolerance		± 5 %; ± 1	%; ± 0.5 %			
Temperature coefficient	± 200 ppm/K; ± 100 ppm/K					
Rated dissipation, P ₇₀ ⁽¹⁾	0.2 W	0.25 W	0.4 W	0.5 W		
Operating voltage, U _{max.} AC _{RMS} /DC	50 V	75 V	150 V	200 V		
Permissible film temperature, $\vartheta_{\text{F max.}}^{(1)}$	ure, ϑ _{F max.} (1) 155 °C					
Operating temperature range		-55 °C to	+155 °C			
Max. resistance change at P_{70} for resistance range, $ \Delta R/R $ after:						
1000 h		≤1.	0 %			
8000 h	≤ 2.0 %					
Permissible voltage against ambient (insulation):						
1 min, U_{ins}	75 V	100 V	200 V	300 V		
Failure rate: FIT _{observed}	≤ 0.1 x 10 ⁻⁹ /h					

Note

APPLICATION INFORMATION

When the resistor dissipates power, a temperature rise above the ambient temperature occurs, dependent on the thermal resistance of the assembled resistor together with the printed circuit board. The rated dissipation applies only if the permitted film temperature is not exceeded.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

⁽¹⁾ Please refer to APPLICATION INFORMATION below



TEMPERATURE COEFFICIENT AND RESISTANCE RANGE								
TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES				
	± 200 ppm/K	± 5 %	1 Ω to 10 M Ω	E24				
RCS0402 e3	± 100 ppm/K	± 1 %	1 Ω to 10 M Ω	E24; E96				
NO30402 e3	± 100 ppm/K	± 0.5 %	1 Ω to 10 M Ω	E24; E96				
	Jumper, I _{max.} = 3 A	≤ 20 mΩ	0 Ω	-				
	± 200 ppm/K	± 5 %	1 Ω to 10 M Ω	E24				
DCC0602 -2	± 100 ppm/K	± 1 %	1 Ω to 10 M Ω	E24; E96				
RCS0603 e3	± 100 ppm/K	± 0.5 %	1 Ω to 10 M Ω	E24; E96				
	Jumper, I _{max.} = 3.5 A	≤ 20 mΩ	0 Ω	=				
	± 200 ppm/K	± 5 %	1 Ω to 10 M Ω	E24				
RCS0805 e3	± 100 ppm/K	± 1 %	1 Ω to 10 M Ω	E24; E96				
RC30605 e3	± 100 ppm/K	± 0.5 %	1 Ω to 10 M Ω	E24; E96				
	Jumper, I _{max.} = 4 A	≤ 20 mΩ	0 Ω	-				
	± 200 ppm/K	± 5 %	1 Ω to 10 M Ω	E24				
DCC1006 - 2	± 100 ppm/K	± 1 %	1 Ω to 10 M Ω	E24; E96				
RCS1206 e3	± 100 ppm/K	± 0.5 %	1 Ω to 10 MΩ	E24; E96				
	Jumper, I _{max.} = 5 A	≤ 20 mΩ	0 Ω	-				

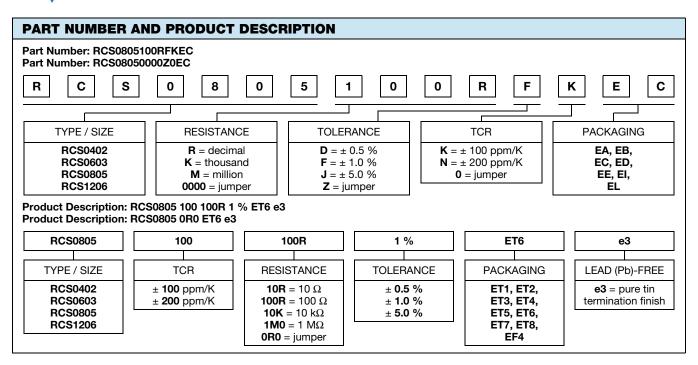
Note

- The temperature coefficient of resistance (TCR) is not specified for 0 Ω jumpers

PACKAGING								
TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE WIDTH		PITCH	PACKAGING DIMENSIONS		
RCS0402 e3	ED = ET7	10 000			2 mm	Ø 180 mm/7"		
NO30402 e3	EE = EF4	50 000			2 111111	Ø 330 mm/13"		
	EI = ET2	5000				Ø 180 mm/7"		
	ED = ET3	10 000		8 mm	2 mm 4 mm 4 mm	Ø 180 mm/7"		
	EL = ET4	20 000				Ø 285 mm/11.25"		
RCS0603 e3	EE = ET8	50 000				Ø 330 mm/13"		
	EA = ET1	5000				Ø 180 mm/7"		
	EB = ET5	10 000	Paper tape according to IEC 60286-3, Type 1a			Ø 285 mm/11.25"		
	EC = ET6	20 000	, , , , , , , , , , , , , , , , , , , ,			Ø 330 mm/13"		
	EA = ET1	5000				Ø 180 mm/7"		
RCS0805 e3	EB = ET5	10 000				Ø 285 mm/11.25"		
	EC = ET6	20 000				Ø 330 mm/13"		
	EA = ET1	5000				Ø 180 mm/7"		
RCS1206 e3	EB = ET5	10 000				Ø 285 mm/11.25"		
	EC = ET6	20 000				Ø 330 mm/13"		



www.vishay.com





Vishay

DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A cermet film layer and a glass-over are deposited on a high grade (Al₂O₃) ceramic substrate with its prepared inner contacts on both sides. A special laser is used to achieve the target value and the desired power dissipation performance by smoothly fine trimming the resistive layer without damaging the ceramics. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure on 100 % of the individual chip resistors. Only accepted products are laid directly into the tape in accordance with **IEC 60286-3 Type 1a** (1).

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapor phase as shown in **IEC 61760-1**. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS-compliant, the pure tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

MATERIALS

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein (2)
- The Global Automotive Declarable Substance List (GADSL) (3)
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) (4) for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see www.vishav.com/how/leadfree.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at www.vishay.com/doc?49037.

APPROVALS

The resistors are qualified according to AEC-Q200.

Where applicable, the resistors are tested in accordance with **EN 140401-802** which refers to **EN 60115-1**, **EN 60115-8** and the variety of environmental test procedures of the **IEC 60068** ⁽¹⁾ series.

RELATED PRODUCTS

For more information about products with superior surge and pulse performance please refer to D/CRCW-IF e3, Pulse Proof Thick Film Chip Resistors datasheet (www.vishav.com/doc?20024).

The CRCW-HP e3 product series is designed for those applications where both enhanced power rating and superior pulse loading performance is required.

For ordering CRCW-HP e3 please refer to latest edition of datasheet (www.vishay.com/doc?20043).

For thick film resistors with standard requirements for power rating, please refer to D/CRCW e3, Standard Thick Film Chip Resistors datasheet (www.vishay.com/doc?20035)

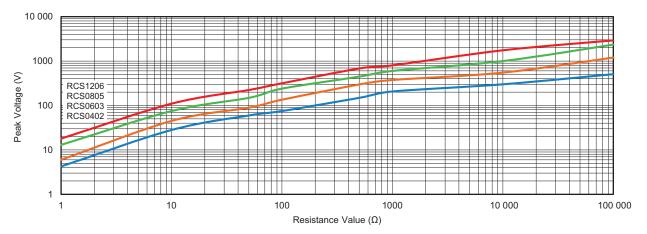
Notes

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents
- (2) The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at http://std.iec.ch/iec62474.
- (3) The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at www.gadsl.org
- (4) The SVHC list is maintained by the European Chemical Agency (ECHA) and available at http://echa.europa.eu/candidate-list-table



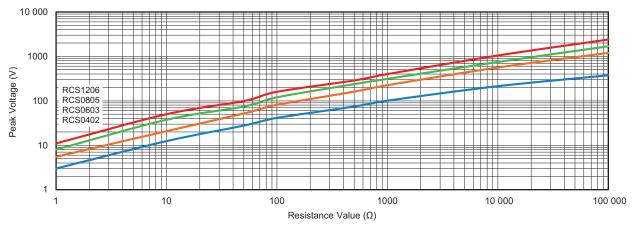
FUNCTIONAL PERFORMANCE

Single Pulse High Power Overload 1.2 µs / 50 µs Pulse



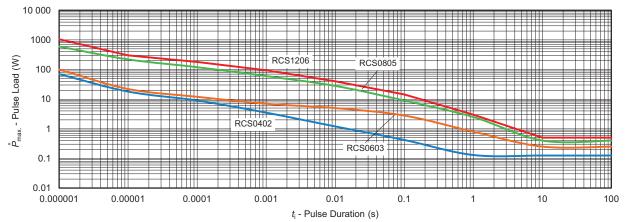
Pulse load rating in accordance with EN 60115-1, 4.27; 1.2 μ s / 50 μ s; 5 pulses at 12 s intervals; for permissible resistance change 1 %

Single Pulse High Power Overload 10 µs / 700 µs Pulse



Pulse load rating in accordance with EN 60115-1, 4.27; 10 μ s / 700 μ s; 10 pulses at 1 min intervals; for permissible resistance change 1 %

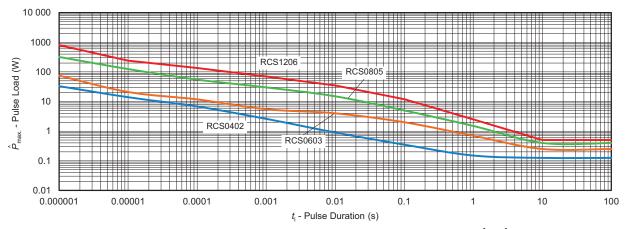
Single Pulse



Maximum pulse load, single pulse; applicable if $\overline{P} \to 0$ and n < 1000 and $\hat{U} = \hat{U}_{\text{max}}$; for permissible resistance change equivalent to 8000 h operation

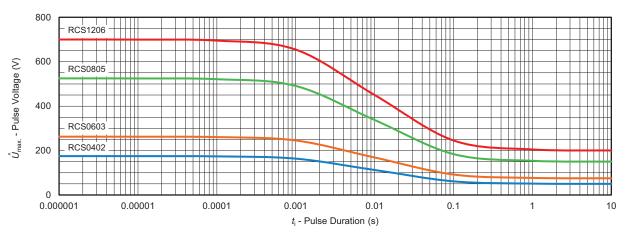


Continuous Pulse



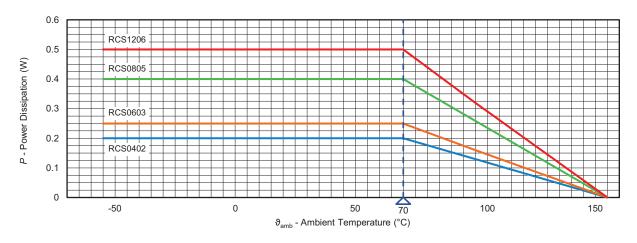
Maximum pulse load, continuous pulses; applicable if $\overline{P} \leq P$ (ϑ_{amb}) and $\hat{U} = \hat{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

Pulse Voltage



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} = \hat{P}_{\text{max}}$; for permissible resistance change equivalent to 8000 h operation

Derating





TESTS AND REQUIREMENTS

All executed tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8 (successor of EN 140400), sectional specification

EN 140401-802, detail specification

IEC 60068-2-xx, test methods

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-802. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA/IS-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, whereupon the following values are applied:

Temperature: 15 °C to 35 °C Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on boards in accordance with EN 60115-8, 2.4.2 unless otherwise specified.

TEST P	ROCEDUI	RES AND REQUIREM	IENTS			
	IEC		PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (△R)		
EN 60115-1 TEST		TEST	PROCEDURE	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER	
CLAUSE	METHOD		Stability for product types:	1 O to	10 ΜΩ	
			RCS e3			
4.5	-	Resistance	-	± 0.5 %; ± 1 %	± 5 %	
4.8	-	Temperature coefficient	At (20 / -55 / 20) °C and (20 / 155 / 20) °C	± 100 ppm/K	± 200 ppm/K	
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R}$ or $U = U_{\text{max.}}$ whichever is the less severe; 1.5 h on; 0.5 h off 70 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)	
			70 °C; 8000 h	± (2 % R + 0.1 Ω)	± (4 % R + 0.1 Ω)	
4.25.3	-	Endurance at upper category temperature	155 °C; 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)	
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (1 % R + 0.05 Ω)		
4.37	67 (Cy)	Damp heat, steady state, accelerated	(85 ± 2) °C; (85 ± 5) % RH $U = \sqrt{0.1 \times P_{85} \times R} \le 100 \text{ V};$ 1000 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)	
4.23	-	Climatic sequence:				
4.23.2	2 (Bb)	Dry heat	125 °C; 16 h			
4.23.3	30 (Db)	Damp	55 °C; 24 h; ≥ 90 % RH; 1 cycle			
4.23.4	1 (Ab)	Cold	-55 °C; 2 h	± (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)	
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 ± 10) °C	1 (1 /071 1 0.00 22)		
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; 24 h; ≥ 90 % RH; 5 cycles			
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}}$; 1 min			
-	1 (Aa)	Cold	-55 °C; 2 h	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$	
4.19	14 (Na)	Rapid change of temperature	30 min. at -55 °C and 30 min. at 125 °C 1000 cycles	\pm (1 % R + 0.05 Ω) no visible damage		
4.13	-	Short time overload	$U = 2.5 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}};$ whichever is the less severe; 5 s	± (2 % R + 0.05 Ω)		
4.27	-	Single pulse high voltage overload	Severity no. 4: $U = 10 \times \sqrt{P_{70} \times R}$ or $U = 2 \times U_{\text{max.;}}$ whichever is the less severe; 10 pulses 10 µs / 700 µs		+ 0.05 Ω) e damage	



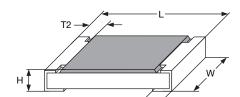
TEST P	ROCEDU	RES AND REQUIREM	ENTS			
	IEC	TEGT	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (△R)		
EN 60115-1	60068-2 ⁽¹⁾ TEST		PROCEDURE	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER	
CLAUSE	METHOD		Stability for product types:	1 Ω to 10 MΩ		
			RCS e3	1 22 10	10 10122	
4.39	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R}$ or $U = 2 \times U_{\text{max.}}$; whichever is the less severe; 0.1 s on; 2.5 s off; 1000 cycles	\pm (1 % R + 0.05 Ω) no visible damage		
4.38	-	Electrostatic discharge (human body model)	IEC 61340-3-1 ⁽¹⁾ ; 3 positive + 3 negative discharges; ESD voltage according to the size	± (1 % R + 0.05 Ω)		
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude \leq 1.5 mm or \leq 200 m/s ² ; 7.5 h	± (0.25 % <i>R</i> + 0.05 Ω) no visible damage	\pm (0.5 % R + 0.05 Ω) no visible damage	
4.17	58 (Td)	Solderability	Solder bath method, SnPb40; non-activated flux (235 ± 5) °C; (2 ± 0.2) s Solder bath method, Sn96.5Ag3Cu0.5; non-activated flux (245 ± 5) °C; (3 ± 0.3) s	Good tinning (≥ 95 % covered); no visible damage		
4.18	58 (Td)	Resistance to soldering heat	Soldering bath method; (260 ± 5) °C; (10 ± 1) s	± (0.25 % R + 0.05 Ω)	± (0.5 % R + 0.05 Ω)	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol +50 °C; method 2	No visible damage		
4.32	21 (Ue ₃)	Shear (adhesion)	RCS0402 e3: 9 N RCS0603 e3 to RCS1206 e3: 17.7 N	No visible damage		
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm; 3 times	\pm (0.25 % R + 0.05 Ω) no visible damage, no open circuit in bent position		
4.7	-	Voltage proof	$U = 1.4 \times U_{\text{ins}}$; 60 s	No flashover	or breakdown	
4.35	-	Flammability, needle flame test	IEC 60695-11-5 ⁽¹⁾ ; 10 s	No burning after 30 s		

Note

 $^{^{(1)}}$ The quoted IEC standards are also released as EN standards with the same number and identical contents

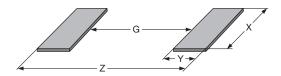


DIMENSIONS



DIMENSIONS AND MASS									
TYPE / SIZE	L (mm)	W (mm)	H (mm)	T1 (mm)	T2 (mm)	MASS (mg)			
RCS0402 e3	1.0 ± 0.05	0.5 ± 0.05	0.35 ± 0.05	0.25 ± 0.05	0.2 ± 0.10	0.65			
RCS0603 e3	1.55 + 0.10 / - 0.05	0.85 ± 0.10	0.45 ± 0.05	0.3 ± 0.20	0.3 ± 0.20	2			
RCS0805 e3	2.0 + 0.20 / - 0.10	1.25 ± 0.15	0.45 ± 0.05	0.3 + 0.20 / - 0.10	0.3 ± 0.20	5.5			
RCS1206 e3	3.2 + 0.10 / - 0.20	1.6 ± 0.15	0.55 ± 0.10	0.45 ± 0.20	0.4 ± 0.20	10			

SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS								
WAVE SOLDERING				REFLOW SOLDERING				
TYPE / SIZE	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)
RCS0402 e3	-	-	-	-	0.45	0.6	0.6	1.65
RCS0603 e3	0.65	1.10	1.25	2.85	0.75	0.75	1.00	2.25
RCS0805 e3	0.90	1.30	1.60	3.50	1.00	0.95	1.45	2.90
RCS1206 e3	1.40	1.40	1.95	4.20	1.50	1.05	1.80	3.60

Notes

- The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g in standards IEC 61188-5-x (1) or in publication IPC-7351
- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

RCS04022R00FKE	RCS04024R99FKEI	RCS060322R1FKE	A RCS06032R67FKE	A RCS06034R99FKEA
RCS080560R4FKEA	RCS120660R4FKEA	RCS04022R20FKED	RCS060324R0FKEA	RCS060362R0FKEA
RCS0402300RFKED	RCS040230K0FKED	RCS04023K01FKED	RCS0402475RFKED	RCS04024K02FKED
RCS040256K0FKED	RCS040262K0FKED	RCS040282K0FKED	RCS0603140KFKEA	RCS060316K0FKEA
RCS060316K9FKEA	RCS060322K1FKEA	RCS0603240RFKEA	RCS060324K9FKEA	RCS06032K10FKEA
RCS06033K32FKEA	RCS060342K2FKEA	RCS060346K4FKEA	RCS0603470KFKEA	RCS06034K87FKEA
RCS060351K1FKEA	RCS0603576KFKEA	RCS0603910RFKEA	RCS06039K09FKEA	RCS0805412RFKEA
RCS08055K11FKEA	RCS0805604RFKEA	RCS12061K60FKEA	RCS1206300KFKEA	RCS120633K2FKEA
RCS1206499KFKEA	RCS0402390RJNED	RCS0603330RJNEA	RCS04022M20FKED	RCS040233R0JNED
RCS0805330RJNEA	RCS0805680RJNEA			